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殿 送信元-TSB SSEC

T-158 P.02/02 U-037

211836US

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION FOR REISSUE OF:
USP 5,929,466 to OHBA ET AL

: EXAMINER:

SERIAL NO.: 08/874,299

FILED: HEREWITH

: GROUP ART UNIT:

FOR: SEMICONDUCTOR DEVICE AND METHOD OF FABRICATING THE
SAME

WRITTEN CONSENT

ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231

SIR:

The assignee of this patent, Kabushiki Kaisha Toshiba, established by assignment of Application Serial No. 08/400,865, now U.S. 5,656,832, the parent of U.S. 5,929,466, recorded at reel 7444, frame nos. 804-806, consents to the filing of this application for the reissue of US 5,929,466. The undersigned, Takashi Nakayama, has the authority to act upon the behalf of the assignee to consent to this reissue.

X  X

Takashi Nakayama

General Manager, Intellectual Property Division

Date

Not dated